

Special Issue

Intelligent Mobile Crowdsensing

Message from the Guest Editors

Intelligent mobile crowdsensing offers a commendable framework for future information gathering, providing a scalable and adaptable solution for various data-driven applications. Its ability to harness the power of AI and mobile technology positions it as a pivotal tool in addressing modern-day challenges through innovative and efficient data collection and analysis strategies.

Studies in this special issue include:

- intelligent data collection and processing
- collaborative sensing systems
- privacy and security protection
- novel incentive mechanisms
- application scenarios and case studies, distributed learning over mobile crowdsensing, etc.

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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